"Half Bridge" Low $V_{CE(on)}$ IGBT INT-A-PAK, 100 A

INT-A-PAK IGBT

FEATURES

- Trench IGBT technology
- Gen 4 FRED Pt® technology anti-parallel diodes with ultra soft reverse recovery characteristics
- Very low conduction losses
- Al_2O_3 DBC
- UL approved file E78996
- Designed for industrial level
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

Pb-free
RoHS COMPLIANT

BENEFITS

- Optimized for high current inverter stages (AC TIG welding machines)
- Direct mounting to heatsink
- Very low junction to case thermal resistance
- Low EMI

PRIMARY CHARACTERISTICS	
V_{CES}	650 V
I_C DC, T_C = 80 °C	185A
$V_{CE(on)}$ at 100 A, 25 °C	1.05 V
Chip level $V_{CE(on)}$ at 100 A, 25 °C	0.98 V
Speed	DC to 1 kHz
Package	INT-A-PAK
Circuit configuration	Half bridge

ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS
Collector to emitter voltage	V_{CES}		650	V
Continuous collector current	I_C	T_C = 25 °C	247	A
		T_C = 80 °C	185	
Pulsed collector current	I_{CM}	T_C = 175 °C, t_p = 6 ms, V_{GE} = 15 V	660	
Peak switching current	I_{LM}		320	
Diode continuous forward current	I_F	T_C = 25 °C	57	
		T_C = 80 °C	43	
Maximum non-repetitive peak current	I_{FSM}	10 ms sine or 6 ms rectangular pulse, T_J = 25 °C	270	
Gate to emitter voltage	V_{GE}		± 20	V
RMS isolation voltage	V_{ISOL}	Any terminal to case, t = 1 min	2500	
Maximum power dissipation (IGBT)	P_D	T_C = 25 °C	517	W
		T_C = 80 °C	328	
Maximum power dissipation (Diode)	P_D	T_C = 25 °C	150	W
		T_C = 80 °C	95	
Operating junction temperature range	T_J		-40 to +175	°C
Storage temperature range	T_{Stg}		-40 to +150	

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ELECTRICAL SPECIFICATIONS (T_J = 25 °C unless otherwise specified)						
PARAMETER	**SYMBOL**	**TEST CONDITIONS**	**MIN.**	**TYP.**	**MAX.**	**UNITS**
Collector to emitter breakdown voltage	$V_{BR(CES)}$	V_{GE} = 0 V, I_C = 400 μA	650	-	-	V
Collector to emitter voltage	$V_{CE(on)}$	V_{GE} = 15 V, I_C = 100 A	-	1.05	1.32	
		V_{GE} = 15 V, I_C = 200 A	-	1.24	-	
		V_{GE} = 15 V, I_C = 100 A, T_J = 125 °C	-	1.02	-	
Gate threshold voltage	$V_{GE(th)}$	V_{CE} = V_{GE}, I_C = 2 mA	4.0	4.8	6.0	
Temperature coefficient of threshold voltage	$\Delta V_{GE(th)}/\Delta T_J$	V_{CE} = V_{GE}, I_C = 2 mA, (25 °C to 125 °C)	-	-14	-	mV/°C
Forward transconductance	g_{fe}	V_{CE} = 20 V, I_C = 100 A	-	102	-	S
Transfer characteristics	V_{GE}	V_{CE} = 20 V, I_C = 100 A	-	6.4	-	V
Collector to emitter leakage current	I_{CES}	V_{GE} = 0 V, V_{CE} = 650 V	-	0.5	100	μA
		V_{GE} = 0 V, V_{CE} = 650 V, T_J = 125 °C	-	0.2	-	
Diode forward voltage drop	V_{FM}	I_C = 50 A, V_{GE} = 0 V	-	2.0	2.9	V
		I_C = 50 A, V_{GE} = 0 V, T_J = 125 °C	-	1.6	-	
Gate to emitter leakage current	I_{GES}	V_{GE} = ± 20 V	-	-	± 240	nA

SWITCHING CHARACTERISTICS (T_J = 25 °C unless otherwise specified)						
PARAMETER	**SYMBOL**	**TEST CONDITIONS**	**MIN.**	**TYP.**	**MAX.**	**UNITS**
Total gate charge	Q_g	I_C = 100 A, V_{CC} = 520 V V_{GE} = 15 V	-	894	-	nC
Gate to emitter charge	Q_{ge}		-	146	-	
Gate to collector charge	Q_{gc}		-	249	-	
Turn-on switching energy	E_{on}	I_C = 100 A, V_{CC} = 325 V, V_{GE} = 15 V, L = 500 μH R_g = 4.7 Ω, T_J = 25 °C	-	0.4	-	mJ
Turn-off switching energy	E_{off}		-	4.5	-	
Total switching energy	E_{ts}		-	4.9	-	
Turn-on delay time	$t_{d(on)}$		-	23	-	ns
Rise time	t_r		-	24	-	
Turn-off delay time	$t_{d(off)}$		-	367	-	
Fall time	t_f		-	113	-	
Turn-on switching energy	E_{on}	I_C = 100 A, V_{CC} = 325 V, V_{GE} = 15 V, L = 500 μH R_g = 4.7 Ω, T_J = 125 °C	-	0.5	-	mJ
Turn-off switching energy	E_{off}		-	6.5	-	
Total switching energy	E_{ts}		-	7	-	
Turn-on delay time	$t_{d(on)}$		-	20	-	ns
Rise time	t_r		-	25	-	
Turn-off delay time	$t_{d(off)}$		-	420	-	
Fall time	t_f		-	152	-	
Reverse bias safe operating area	RBSOA	T_J = 175 °C, I_C = 320 A, V_{CC} = 325 V, V_p = 650 V, R_g = 4.7 Ω, V_{GE} = 15 V to 0 V, L = 500 μH	Fullsquare			
Diode reverse recovery time	t_{rr}	I_F = 50 A, dI_F/dt = 500 A/μs, V_{rr} = 200 V	-	79	-	ns
Diode peak reverse current	I_{rr}		-	10.5	-	A
Diode recovery charge	Q_{rr}		-	409	-	nC
Diode reverse recovery time	t_{rr}	I_F = 50 A, dI_F/dt = 500 A/μs, V_{rr} = 200 V, T_J = 125 °C	-	141	-	ns
Diode peak reverse current	I_{rr}		-	19	-	A
Diode recovery charge	Q_{rr}		-	1336	-	nC

THERMAL AND MECHANICAL SPECIFICATIONS						
PARAMETER		**SYMBOL**	**MIN.**	**TYP.**	**MAX.**	**UNITS**
Operating junction temperature range		T_J	-40	-	175	°C
Storage temperature range		T_{Stg}	-40	-	150	
Junction to case	per switch	R_{thJC}	-	-	0.29	°C/W
	per diode		-	-	1.00	
Case to sink per module		R_{thCS}	-	0.1	-	
Mounting torque	case to heatsink		-	-	4	Nm
	case to terminal 1, 2, 3		-	-	3	
Weight			-	185	-	g

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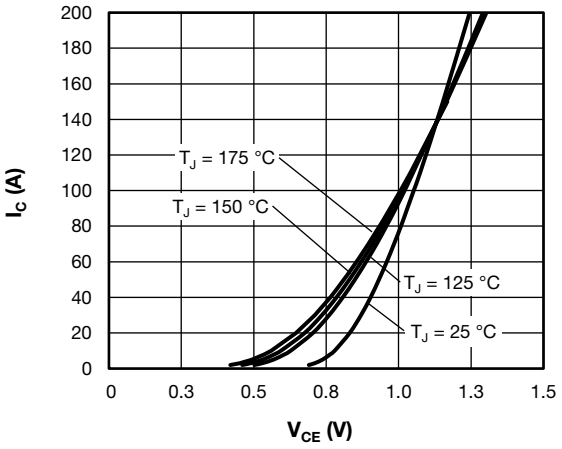

Fig. 1 - Typical Trench IGBT Output Characteristics, V_{GE} = 15 V

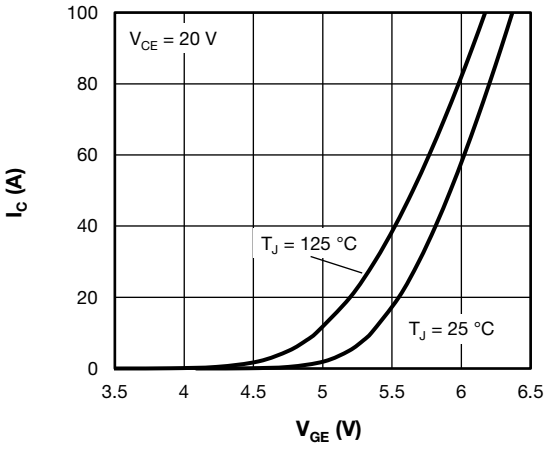

Fig. 4 - Typical Trench IGBT Transfer Characteristics

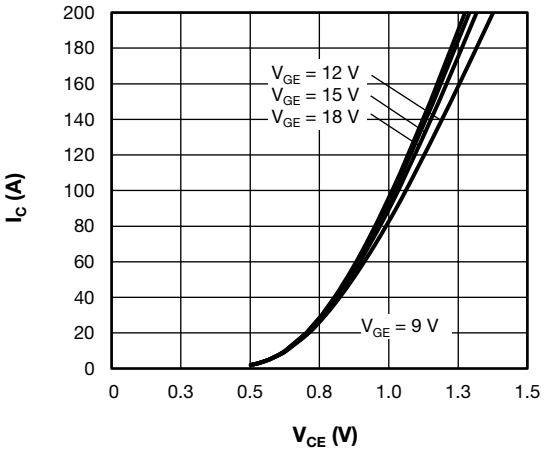

Fig. 2 - Typical Trench IGBT Output Characteristics, T_J = 125 °C

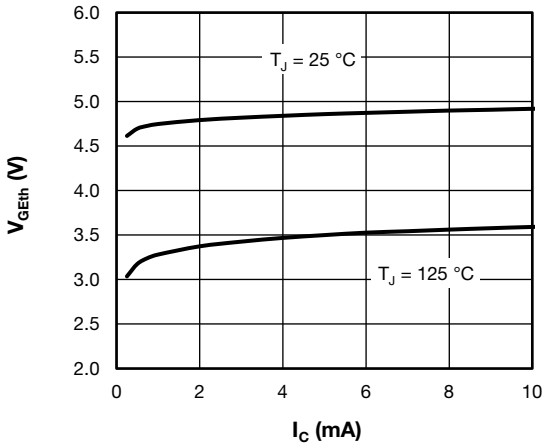

Fig. 5 - Typical Trench IGBT Gate Threshold Voltage

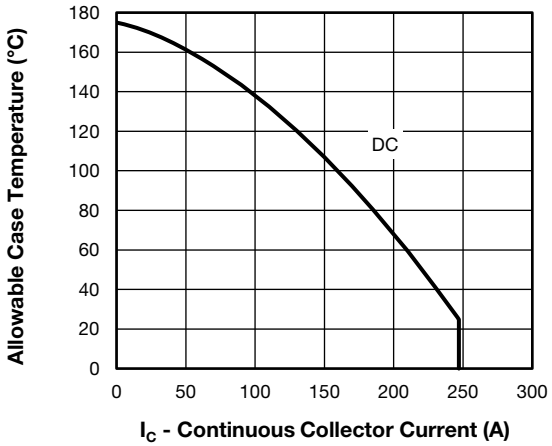

Fig. 3 - Maximum Trench IGBT Continuous Collector Current vs. Case Temperature

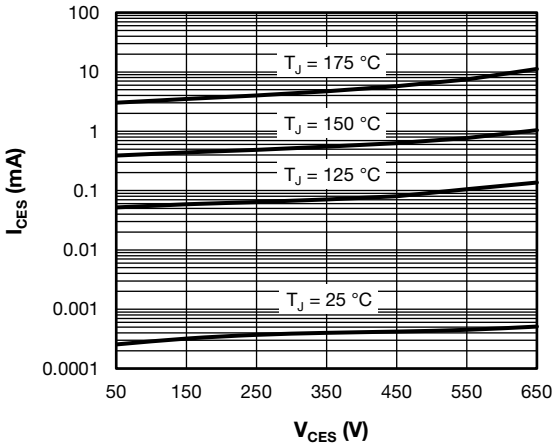

Fig. 6 - Typical Trench IGBT Zero Gate Voltage Collector Current

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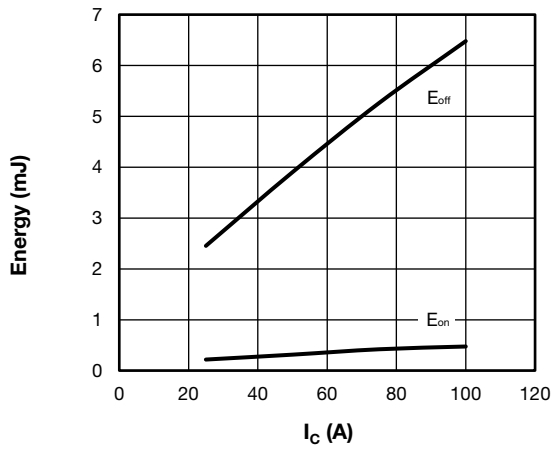

Fig. 7 - Typical Trench IGBT Energy Loss vs. I_C
(with Antiparallel Diode)
T_J = 125 °C, V_{CC} = 325 V, R_g = 4.7 Ω, V_{GE} = +15 V/-15 V, L = 500 μH

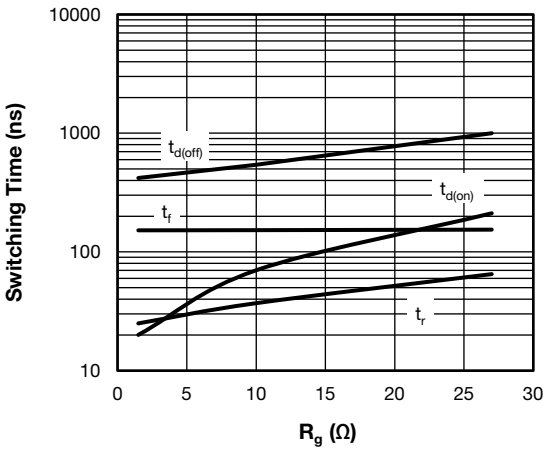

Fig. 10 - Typical Trench IGBT Switching Time vs. R_g
(with Antiparallel Diode)
T_J = 125 °C, V_{CC} = 325 V, I_C = 100 A, V_{GE} = +15 V/-15 V, L = 500 μH

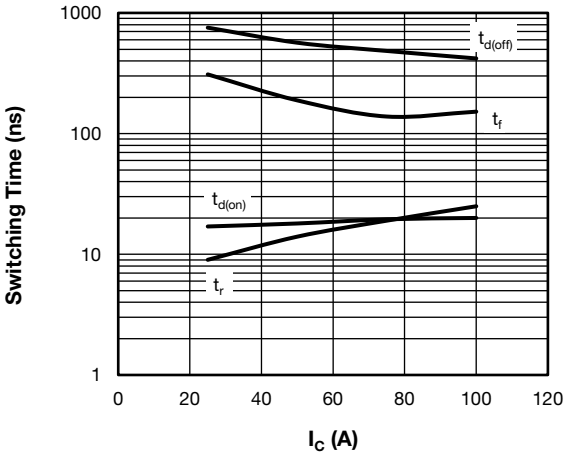

Fig. 8 - Typical Trench IGBT Switching Time vs. I_C
(with Antiparallel Diode)
T_J = 125 °C, V_{CC} = 325 V, R_g = 4.7 Ω, V_{GE} = +15 V/-15 V, L = 500 μH

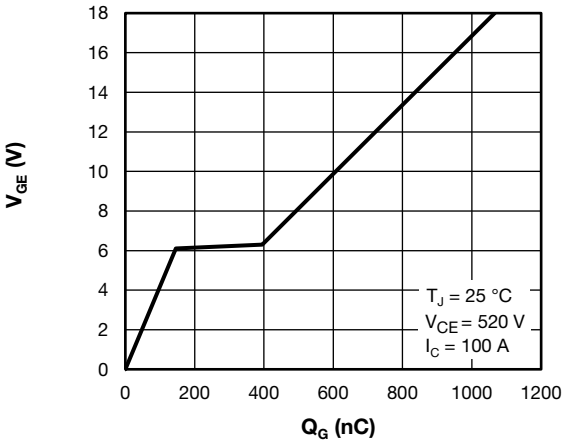

Fig. 11 - Typical Trench IGBT Gate Charge vs.
Gate to Collector Voltage

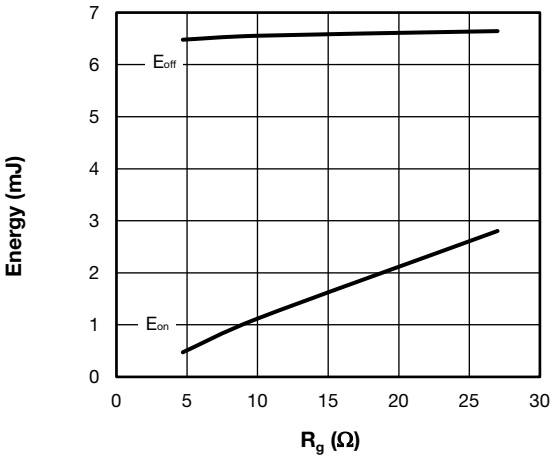

Fig. 9 - Typical Trench IGBT Energy Loss vs. R_g
(with Antiparallel Diode)
T_J = 125 °C, V_{CC} = 325 V, I_C = 100 A, V_{GE} = +15 V/-15 V, L = 500 μH

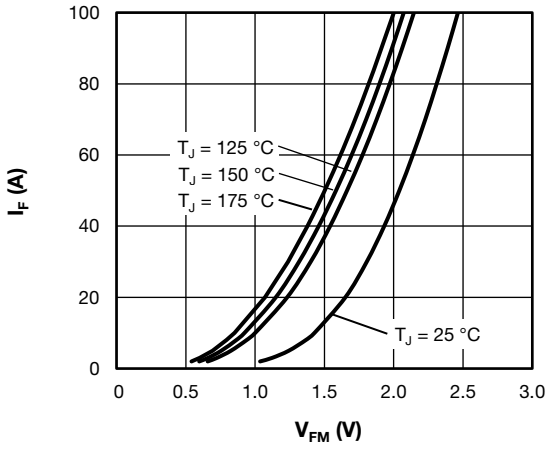

Fig. 12 - Typical Antiparallel Diode Forward Characteristics

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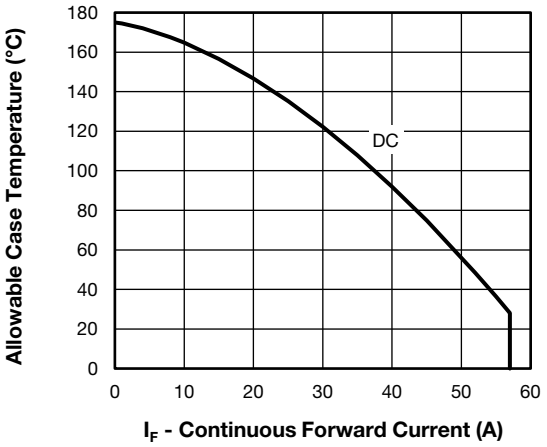

Fig. 13 - Maximum Antiparallel Diode Continuous Forward Current vs. Case Temperature

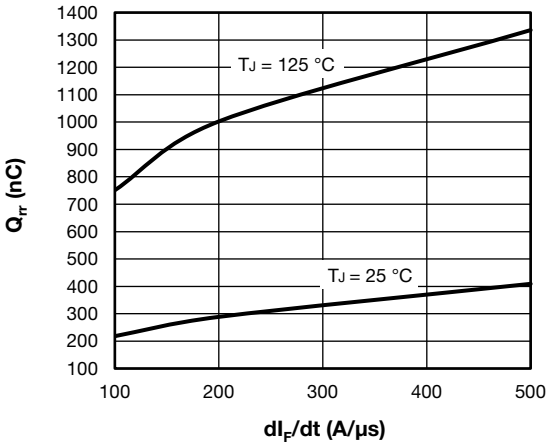

Fig. 16 - Typical Antiparallel Diode Reverse Recovery Charge vs. dI_Fdt
I_F = 50 A, V_{CC} = 200 V

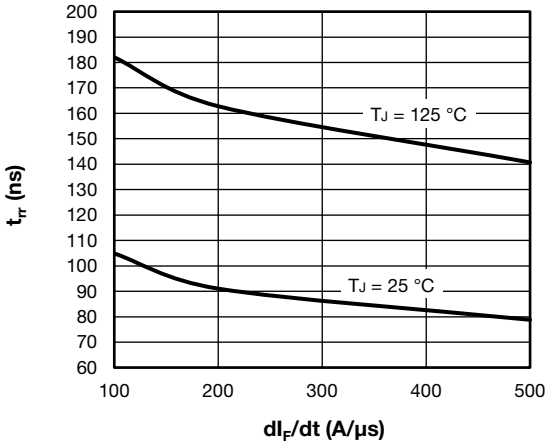

Fig. 14 - Typical Antiparallel Diode Reverse Recovery Time vs. dI_Fdt
I_F = 50 A, V_{CC} = 200 V

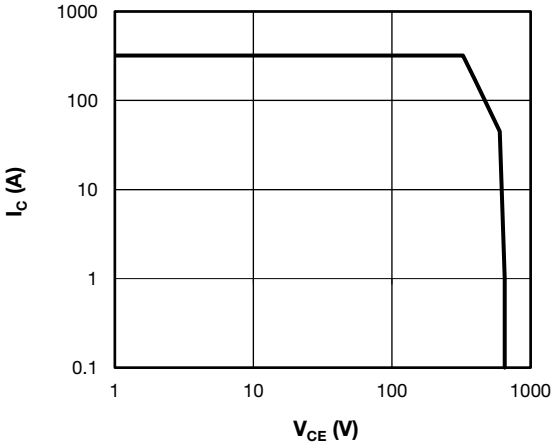

Fig. 17 - Trench IGBT Reverse BIAS SOA
T_J = 175 °C, V_{GE} = 15 V

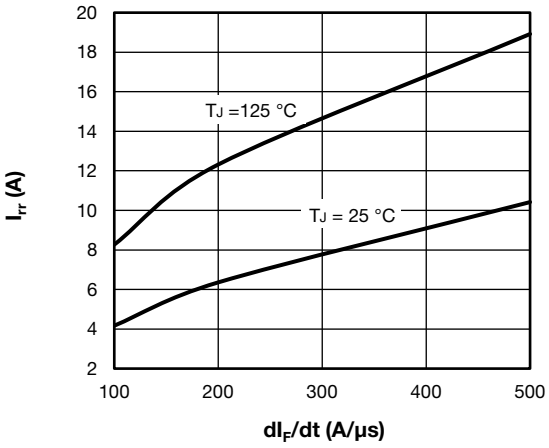

Fig. 15 - Typical Antiparallel Diode Reverse Recovery Current vs. dI_Fdt
I_F = 50 A, V_{CC} = 200 V

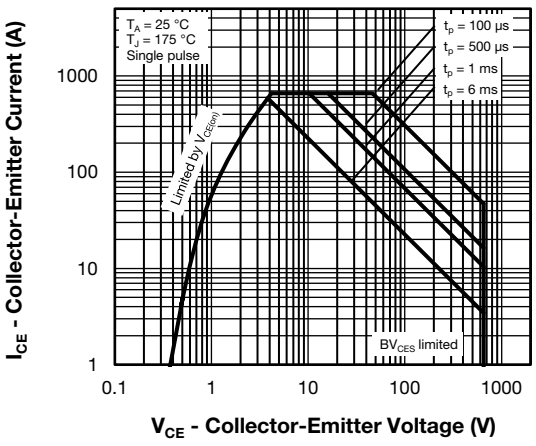

Fig. 18 - Trench IGBT Safe Operating Area

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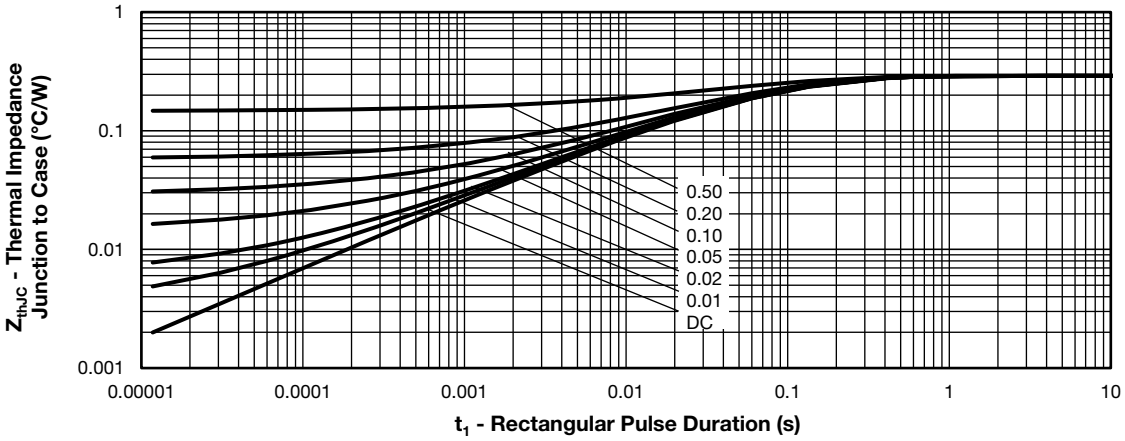

Fig. 19 - Maximum Trench IGBT Thermal Impedance Z_{thJC} Characteristics

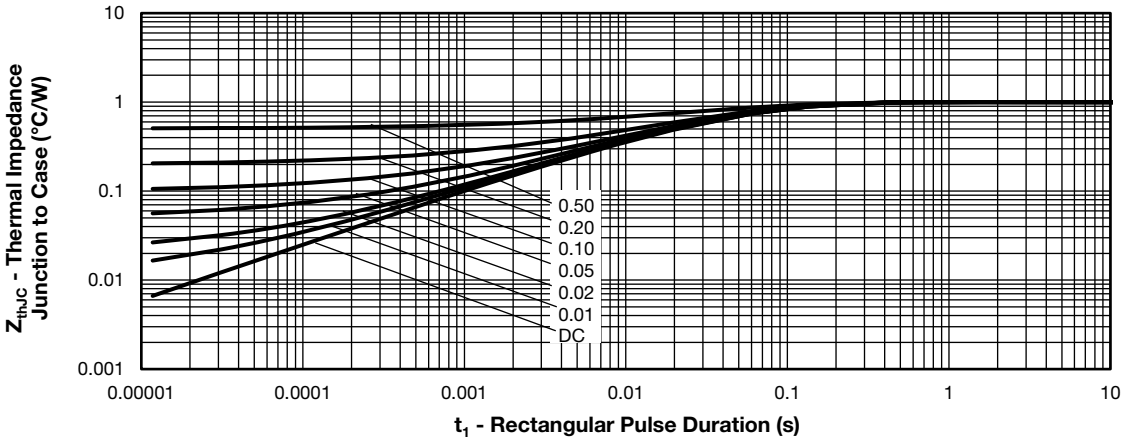

Fig. 20 - Maximum Antiparallel Diode Thermal Impedance Z_{thJC} Characteristics

ORDERING INFORMATION TABLE

Device code	VS-	GT	100	T	S	065	S
	1	2	3	4	5	6	7

1	-	Vishay Semiconductors product
2	-	IGBT die technology (GT = trench)
3	-	Current rating (100 = 100 A)
4	-	Circuit configuration (T = half bridge)
5	-	Package indicator (S = INT-A-PAK)
6	-	Voltage code (065 = 650 V)
7	-	Speed/type (S = standard speed IGBT)

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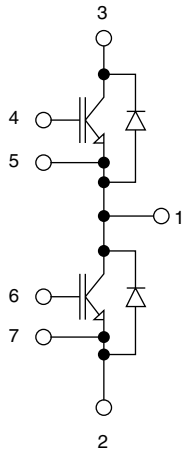
CIRCUIT CONFIGURATION



LINKS TO RELATED DOCUMENTS	
Dimensions	www.vishay.com/doc?95173

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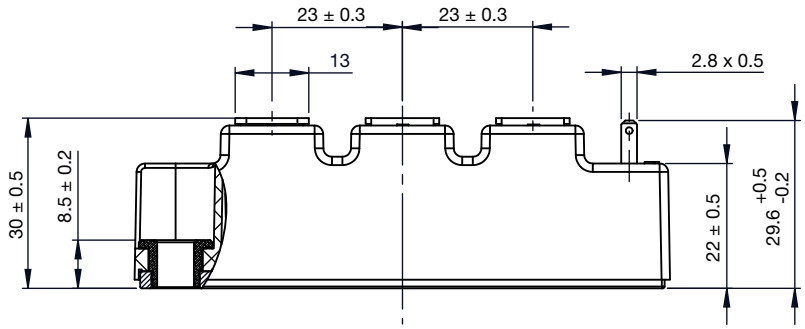
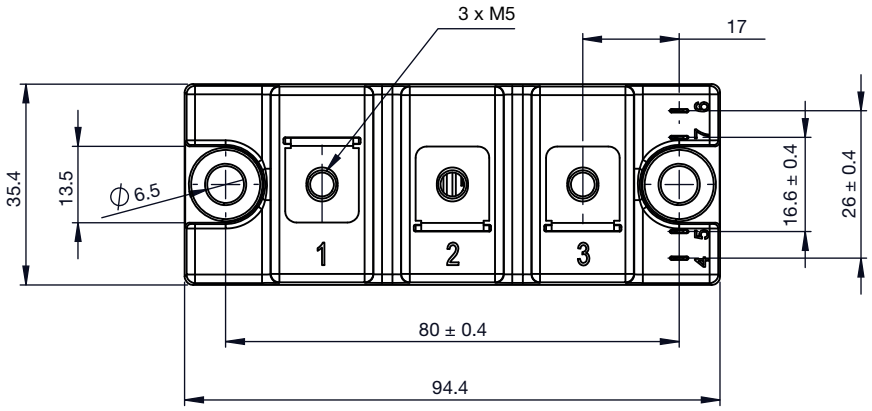
DIMENSIONS in millimeters (inches)





General tolerance ± 0.5 mm

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